

KEC10B (.110" x .110")

◆ Product Features

High Q, High Power, Low ESR/ESL, Low Noise, High Self-Resonance,
Ultra- Stable Performance.

◆ Product Application

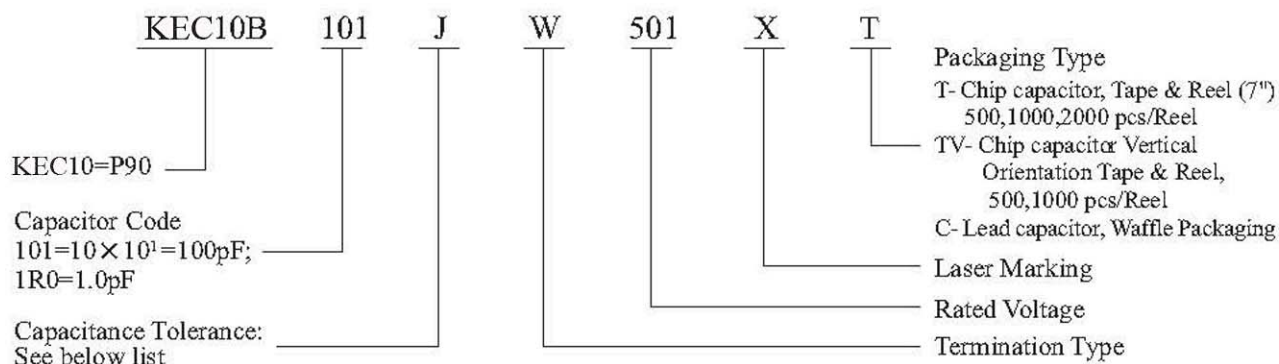
Typical Functional Applications: Bypass, Coupling, Tuning, Feedback, Impedance Matching and D.C. Blocking.

Typical Circuit Applications: UHF/Microwave RF Power Amplifiers, Mixers, Oscillators, Low Noise Amplifiers,
Filter Networks, Timing Circuits and Delay Lines

◆ KEC10B Capacitance Table

Cap.pF	Code	Tol.	Rated WVDC	Cap.pF	Code	Tol.	Rated WVDC	Cap.pF	Code	Tol.	Rated WVDC	Cap.pF	Code	Tol.	Rated WVDC
0.1	0R1	A, B	500V Code 501 or 1500V Code 152	3.6	3R6	A, B, C, D	500V Code 501 or 1500V Code 152	43	430	F, G, J	500V Code 501 or 1500V Code 152	510	511	F, G, J	100V Code 101 or 200V Code 201
0.2	0R2			3.9	3R9			47	470			560	561		
0.3	0R3			4.3	4R3			51	510			620	621		
0.4	0R4			4.7	4R7			56	560			680	681		
0.5	0R5	5.1		5R1	62			620	750			751			
0.6	0R6	5.6		5R6	68			680	820			821			
0.7	0R7	6.2		6R2	75			750	910			911			
0.8	0R8	6.8		6R8	82			820	1000			102			
0.9	0R9	7.5		7R5	91			910							
1.0	1R0	8.2		8R2	100			101							
1.1	1R1	9.1		9R1	110			111							
1.2	1R2	10		100	120	121									
1.3	1R3	11		110	130	131									
1.4	1R4	12		120	150	151									
1.5	1R5	13		130	160	161									
1.6	1R6	15		150	180	181									
1.7	1R7	16		160	200	201									
1.8	1R8	18		180	220	221									
1.9	1R9	20		200	240	241									
2.0	2R0	22		220	270	271									
2.1	2R1	24		240	300	301									
2.2	2R2	27		270	330	331									
2.4	2R4	30		300	360	361									
2.7	2R7	33		330	390	391									
3.0	3R0	36		360	430	431									
3.3	3R3	39		390	470	471									

◆ **Part Numbering**


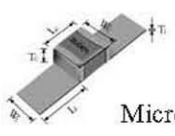



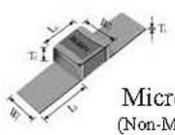
Code	A	B	C	D	F	G	J
Tolerance	± 0.05pF	± 0.1pF	± 0.25pF	± 0.5pF	± 1%	± 2%	± 5%

Note: Tolerance of ± 0.02pF is a possibility. Please contact Kete

◆ **KEC10B Capacitor Dimensions**

unit:inch(millimeter)

Series	Term. Code	Type / Outlines	Capacitor Dimensions				Lead Dimensions			Plated Material
			Length (L _c)	Width (W _c)	Thick. (T _c)	Overlap (B)	Length (L _L)	Width (W _L)	Thickness (T _L)	
10B	W	 Chip	.110+.020 to -.010 (2.79+0.51 to -0.25)	.110 ± .010 (2.79 ±0.25)	.10 (2.54) max	.024 (0.60) max	—	—	—	100% Sn over Nickel Plating
	L									90 Sn10Pb over Nickel Plating
10B	MS	 Microstrip	.135 ± .015 (3.43 ±0.38)	.110 ± .010 (2.79 ±0.25)	.10 (2.54) max	—	.250 (6.35) min	.093 ± .005 (2.36 ±0.13)	.008±.001 (0.2± 0.025) .004±.001 (0.1± 0.025)	Silver- plated Copper 100% Silver

Series	Term. Code	Type / Outlines	Capacitor Dimensions				Lead Dimensions			Plated Material
			Length (L _c)	Width (W _c)	Thick. (T _c)	Overlap (B)	Length (L _L)	Width (W _L)	Thickness (T _L)	
10B	P	 Chip (Non-Magnetic)	.110+.020 to -.010 (2.79+0.51 to -0.25)	.110 ± .010 (2.79 ±0.25)	.10 (2.54) max	.024 (0.60) max	—	—	—	100% Sn over Copper Plating RoHS Compliant
10B	MN	 Microstrip (Non-Magnetic)	.135 ± .015 (3.43 ±0.38)	.110 ± .010 (2.79 ±0.25)	.10 (2.54) max	—	.250 (6.35) min	.093 ± .005 (2.36 ±0.13)	.008±.001 (0.2± 0.025) .004±.001 (0.1± 0.025)	Silver- plated Copper 100% Silver

Note: non-mag is no magnetism.

◆ Performance

Item	Specifications
Quality Factor (Q)	greater than 10,000 at 1 MHz
Insulation Resistance (IR)	0.1 pF to 470 pF: 10 ⁶ Megohms min. @ +25 °C at rated WVDC. 10 ⁵ Megohms min. @ +125 °C at rated WVDC. 510 pF to 1000 pF: 10 ⁵ Megohms min. @ +25 °C at rated WVDC. 10 ⁴ Megohms min. @ +125 °C at rated WVDC.
Rated Voltage	See Rated Voltage Table
Dielectric Withstanding Voltage (DWV)	250% of Rated Voltage for 5 seconds, Rated Voltage ≤ 500VDC 150% of Rated Voltage for 5 seconds, 500VDC < Rated Voltage ≤ 1250VDC 120% of Rated Voltage for 5 seconds, Rated Voltage > 1250VDC
Operating Temperature Range	−55 °C to +200 °C.
Temperature Coefficient (TC)	+90 ± 20 ppm/°C (−55 °C to +125 °C) ;
Capacitance Drift	± 0.02% or ± 0.02pF, whichever is greater.
Piezoelectric Effects	None
Termination Type	See Termination Type Table

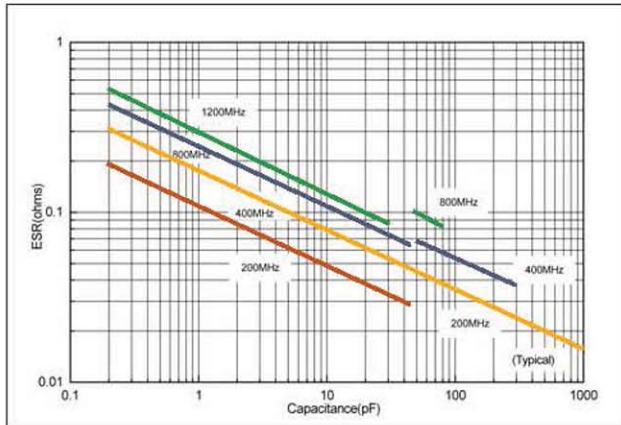
Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

◆ Environmental Tests

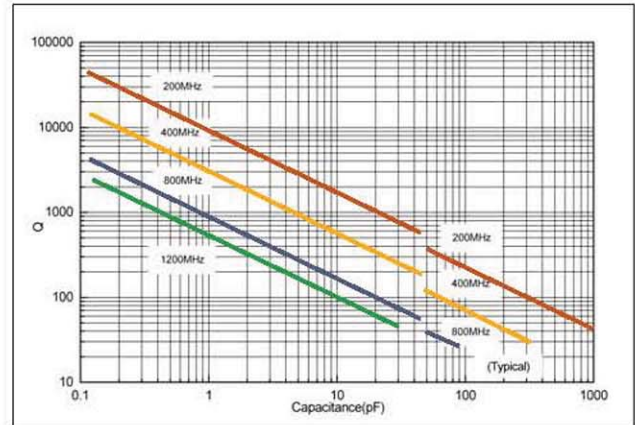
Item	Specifications	Method
Thermal Shock	DWV: the initial value IR: Shall not be less than 30% of the initial value Capacitance change: no more than 0.5% or 0.5pF. whichever is greater.	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (−55 °C and 200 °C) stay 30 minutes. The time of removing shall not be more than 3 minutes. Perform the five cycles.
Moisture Resistance		MIL-STD-202, Method 106.
Humidity (steady state)	DWV: the initial value IR: the initial value Capacitance change: no more than 0.3% or 0.3pF. whichever is greater.	MIL-STD-202, Method 103, Condition A, with 1.5 Volts D.C. applied while subjected to an environment of 85 °C with 85% relative humidity for 240 hours minimum.
Life	IR: Shall not be less than 30% of the initial value Capacitance change: no more than 2.0% or 0.5pF whichever is greater.	MIL-STD-202, Method 108, for 2000 hours, at 200 °C. 200% of Rated Voltage for Capacitors, Rated Voltage ≤ 500VDC 120% of Rated Voltage for Capacitors, 500VDC < Rated Voltage ≤ 1250VDC 100% of Rated Voltage for Capacitors, Rated Voltage > 1250VDC

◆ **KEC10B Performance Curve**

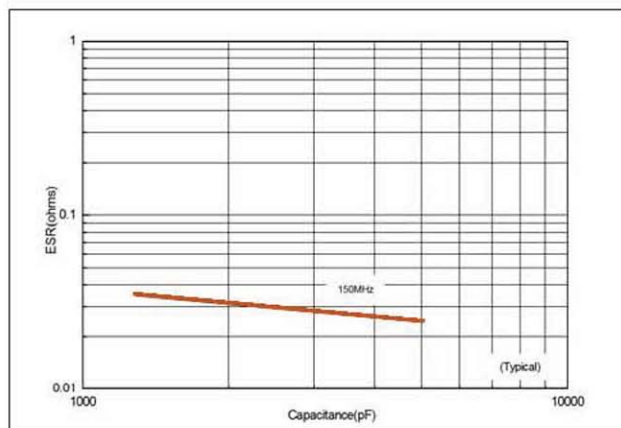
ESR vs Capacitance



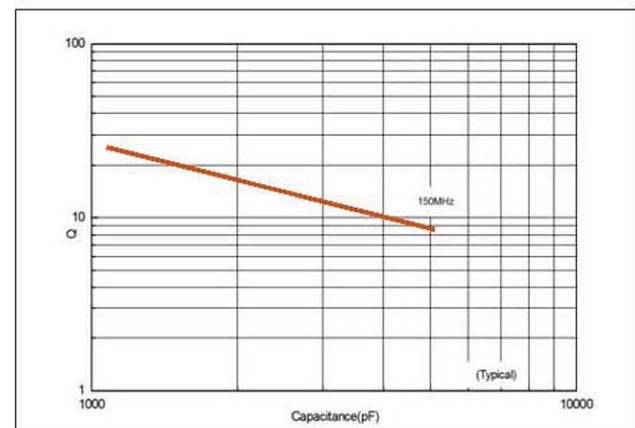
Q vs Capacitance



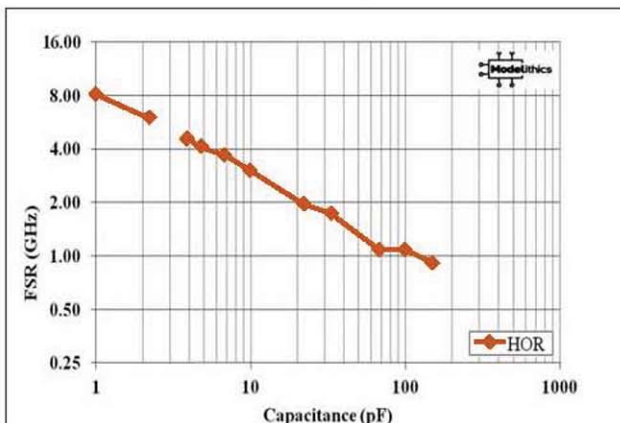
ESR vs Capacitance



Q vs Capacitance



KEC10B Horizontal First Series Resonance (FSRs)



Definitions and Measurement Conditions

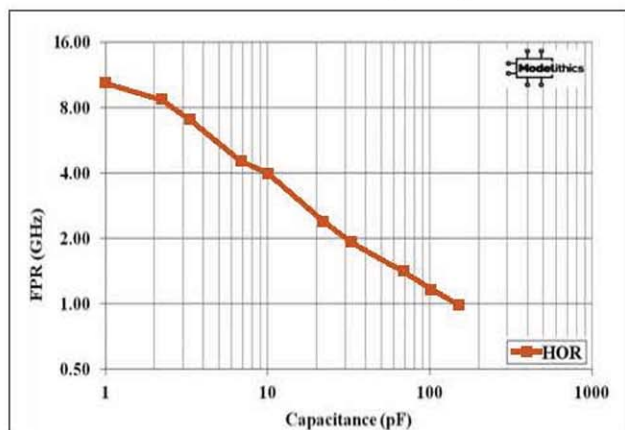
For a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace, with 50-Ohm source and termination resistances, the First Series Resonance, FSR, is defined as the lowest frequency at which the imaginary part of the input impedance, $\text{Im}[Z_{in}]$, equals zero. Should $\text{Im}[Z_{in}]$ or the real part of the input impedance, $\text{Re}[Z_{in}]$, not be monotonic with frequency at frequencies lower than those at which $\text{Im}[Z_{in}] = 0$, the FSR shall be considered as undefined (gap in plot above). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined above; and mounting pad dimensions.

The measurement conditions are: substrate -- Rogers RO4350; substrate dielectric constant -- 3.66; horizontal mount substrate thickness (mils) -- 50; gap in microstrip trace (mils) -- 72; horizontal mount microstrip trace width (mils) -- 110. Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by Kete. The models are derived from measurements on a large number of parts disposed on several different substrates.

◆ KEC10B Performance Curve

KEC10B Horizontal First Parallel Resonance(FPRs)



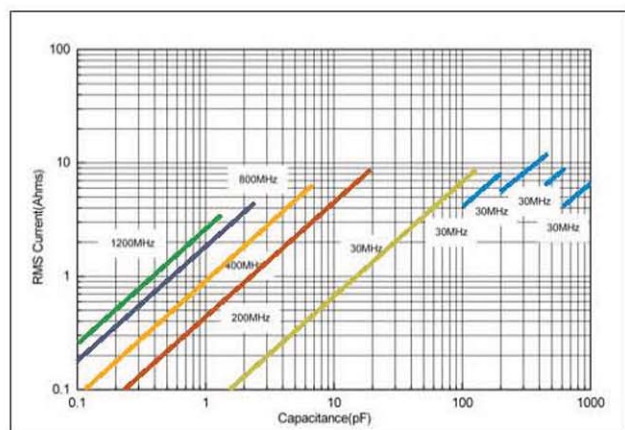
Definitions and Measurement conditions:

For a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace, with 50-Ohm source and termination resistances, the First Parallel Resonance, FPR, is defined as the lowest frequency at which a suckout or notch appears in [S21]. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A horizontal orientation means the capacitor electrode planes are parallel to the plane of the substrate; a vertical orientation means the electrode planes are perpendicular to the substrate.

The measurement conditions are: substrate -- Rogers RO4350; substrate dielectric constant -- 3.66; horizontal mount substrate thickness (mils) -- 50; gap in microstrip trace (mils) -- 72; horizontal mount microstrip trace width (mils) -- 110. Reference planes at sample edges.

All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by KEC. The models are derived from measurements on a large number of parts disposed on several different substrates.

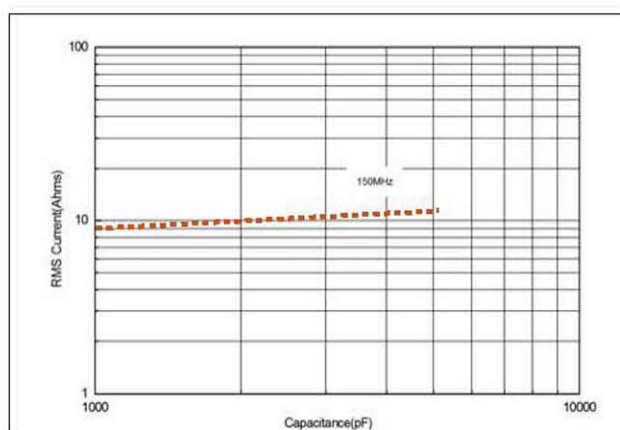
Current Rating vs Capacitance



The current depends on voltage limited: $I = \frac{\sqrt{2}}{2} I_{peak} = \frac{\sqrt{2}}{2} \times \frac{V_{rated}}{X_c} = \sqrt{2} \pi f C V_{rated}$

The current depends on power dissipation limited: $I = \sqrt{\frac{P_{dissipation}}{ESR}}$

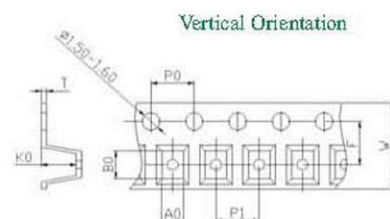
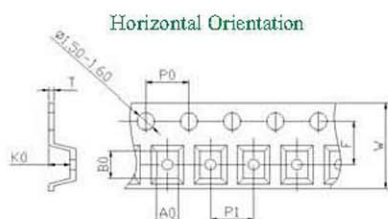
Current Rating vs Capacitance



Note: If the thermal resistance of mounting surface is 20°C/W, then a power dissipation of 3 W will result in the current limited we can calculate the current limited $I = \sqrt{\frac{P_{dissipation}}{ESR}}$

◆ Tape & Reel Specifications

Orientation	EIA	A0	B0	K0	W	P0	P1	T	F	Qty/reel	Tape Material
Horizontal	1111	2.85	3.90	1.95	8.00	4.00	4.00	0.22	3.50	2000	Plastic
Vertical	1111	2.00	3.50	2.70	12.00	4.00	4.00	0.40	5.50	1500	Plastic
Vertical	1111	2.96	3.60	2.40	8.00	4.00	4.00	0.22	3.50	1500	Plastic



◆ Design Kits

These capacitors are 100% RoHS. Kits are available in Magnetic and Non-Magnetic that contain 10(ten) pieces per value.

Design Kit	Description (pF)	Values (pF)	No. of values	Tolerance
DKKEC10B01	1.0 - 10	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7	16	$\pm 0.10\text{pF}$
		3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2		$\pm 0.25\text{pF}$
		10		$\pm 5\%$
DKKEC10B02	10 - 100	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100	16	$\pm 5\%$
DKKEC10B03	100 - 1000	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000	16	$\pm 5\%$
DKKEC10B05	1.0 - 10 Non-magnetic	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7,	16	$\pm 0.10\text{pF}$
		3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2		$\pm 0.25\text{pF}$
		10		$\pm 5\%$
DKKEC10B06	10 - 100 Non-magnetic	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100	16	$\pm 5\%$
DKKEC10B07	100 - 1000 Non-magnetic	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000	16	$\pm 5\%$

